VS-1ENH01HM3, VS-1ENH02HM3

Vishay Semiconductors



Ultrafast Rectifier, 1 A FRED Pt[®]



Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1 A			
V _R	100 V, 200 V			
V _F at I _F	0.69 V			
I _{FSM}	40 A			
t _{rr} (typ.)	23 ns			
T _J max.	175 °C			
Package	SMP (DO-220AA)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.0 mm
- · Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- For PFC, CRM snubber operation
- AEC-Q101 qualified
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber, industrial, and automotive applications.

MECHANICAL DATA

Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse	VS-1ENH01HM3	M		100	V	
voltage	VS-1ENH02HM3	V _{RRM}		200	v	
Average rectified forward	current	I _{F(AV)}	T _C = 168 °C	1	^	
Non-repetitive peak surge	current	I _{FSM}	$T_J = 25$ °C, 10 ms sine pulse	40	A	
Operating junction and sto	rage temperatures	T _J , T _{Stg}		-55 to +175	°C	

ELECTRICAL SPECIFICATIONS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage,	VS-1ENH01HM3	V _{BR} ,	100.04	100	-	-	
blocking voltage	VS-1ENH02HM3	$V_{\rm R}^{\rm BR}$ $I_{\rm R} = 100 \mu {\rm A}$		200	-	-	v
Forward voltage		V _F	I _F = 1 A	-	0.86	0.92	V
			I _F = 1 A, T _J = 150 °C	-	0.69	0.74	
Reverse leakage current			$V_{R} = V_{R}$ rated	-	-	2	μA
			$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	20	
Junction capacitance		CT	V _R = 200 V	-	8	-	pF

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COMPLIANT HALOGEN

FREE



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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS			MAX.	UNITS
		I _F = 1.0 A, dI _F /dt = 100 A/μs, V _R = 30 V		-	23	-	
Reverse recovery time	t _{rr}	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	28	
		T _J = 25 °C		-	14	-	ns
		T _J = 125 °C		-	22	-	
Peak recovery current I _{RRM}		T _J = 25 °C	I _F = 1 A dI _F /dt = 200 A/μs V _R = 100 V	-	1.7	-	A
	IRRM	T _J = 125 °C		-	2.7	-	
Reverse recovery charge Q	0	T _J = 25 °C		-	10	-	
	Qrr	T _J = 125 °C		-	29	-	10

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and s range	storage temperature	T _J , T _{Stg}		-55	-	175	°C
Thermal resistance, junction to mount		R _{thJM} ⁽¹⁾	Infinite heatsink	-	7	9	°C/W
Thermal resistance, junction to ambient		R _{thJA}	PCB footprint 4.8 mm x 4.8 mm	-	107	-	0/11
Approximate weight					0.024		g
Marking davias	VS-1ENH01HM3			1H1			
Marking device VS-1ENH02HM3			Case style SMP (DO-220AA)	1H2			

Note

⁽¹⁾ Thermal resistance junction to mount follows JEDEC[®] 51-14 transient dual interface test method (TDIM)

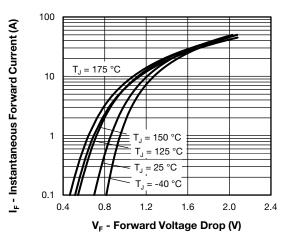


Fig. 1 - Typical Forward Voltage Drop Characteristics

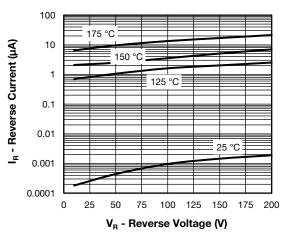


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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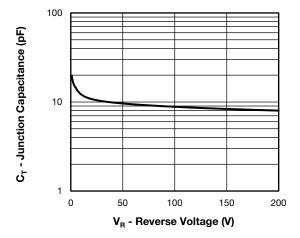


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

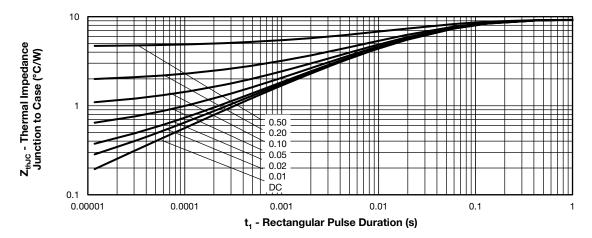


Fig. 4 - Transient Thermal Impedance, Junction to Case

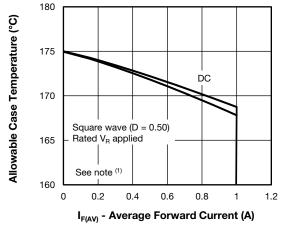


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

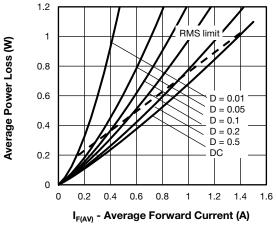


Fig. 6 - Forward Power Loss Characteristics

Revision: 24-Oct-2022

3

Document Number: 96544

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VS-1ENH01HM3, VS-1ENH02HM3

125 °C

dl_F/dt (A/µs)

Fig. 8 - Typical Stored Charge vs. dl_F/dt

40 35

30

25 20

15

10

5

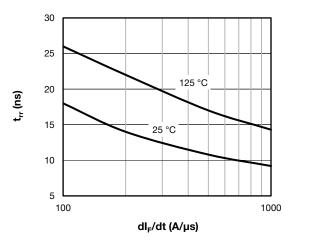
100

Qrr (nC)

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25 °C

1000



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Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Note

- ⁽¹⁾ Formula used: $T_C = T_J (Pd + Pd_{REV}) \times R_{thJC}$;
- $\begin{array}{l} \mbox{Pd} = \mbox{forward power loss} = \mbox{I}_{F(AV)} \times \mbox{V}_{FM} \mbox{ at } (\mbox{I}_{F(AV)}/\mbox{D}) \mbox{ (see fig. 5);} \\ \mbox{Pd}_{REV} = \mbox{inverse power loss} = \mbox{V}_{R1} \times \mbox{I}_{R} \mbox{ (1 D); I}_{R} \mbox{ at } \mbox{V}_{R1} = \mbox{rated } \mbox{V}_{R} \end{array}$

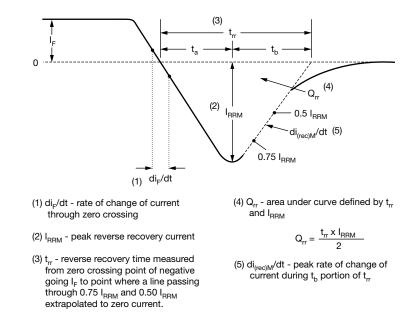
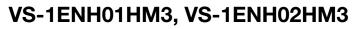


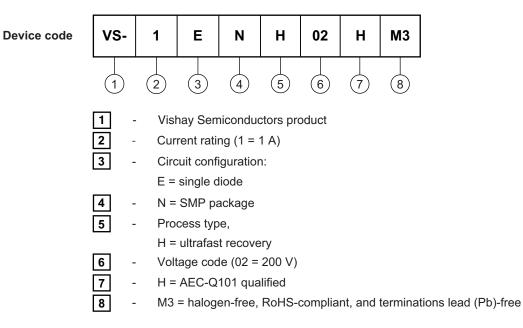
Fig. 9 - Reverse Recovery Waveform and Definitions



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ORDERING INFORMATION TABLE



ORDERING INFORMATION (Example)						
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-1ENH01HM3/84A	84A	3000	7" diameter plastic tape and reel			
VS-1ENH01HM3/85A	85A	10 000	13" diameter plastic tape and reel			
VS-1ENH02HM3/84A	84A	3000	7" diameter plastic tape and reel			
VS-1ENH02HM3/85A	85A	10 000	13" diameter plastic tape and reel			

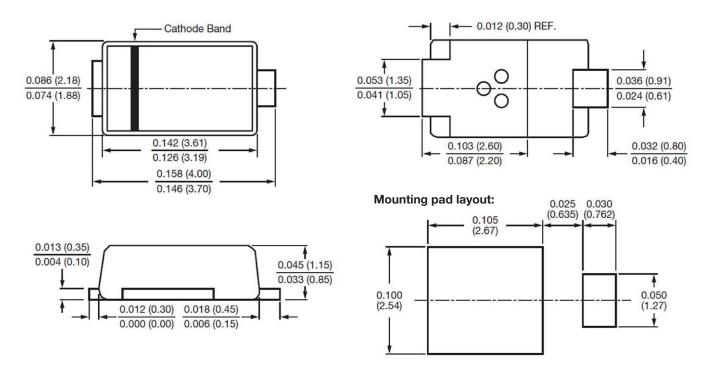
LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?96547					
Part marking information	www.vishay.com/doc?96574				
Packaging information	www.vishay.com/doc?88869				
SPICE model	www.vishay.com/doc?96550				



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SMP (DO-220AA)

DIMENSIONS in inches (millimeters)





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1